



SEI ILLINOIS CHAPTER 2012 SCHOLARSHIP

The Structural Engineering Institute (SEI) Illinois Chapter (Structural Group) is seeking candidates for two academic scholarships in the amount of \$2,500 each. The scholarships will be awarded to undergraduate/graduate students on April 11, 2012 at the ASCE National President Elect/ Student Awards Dinner. The scholarship recipients will be notified in mid March of 2012.

To be eligible for the scholarship award, candidates must meet the following criteria:

- Full-time undergraduate or graduate student majoring in Civil Engineering with a focus in the field of Structural Engineering with an expected graduation date after August 2012.
- Enrolled in a Civil Engineering program at The University of Illinois at Chicago, Illinois Institute of Technology or Northwestern University.
- Member of ASCE, Illinois Section or the local student chapter.

Candidates will be evaluated by the selection committee on the following basis weighted equally:

- Academic Performance
- Work experience or involvement in community and other extracurricular activities
- Essay Response
- Two Letters of Recommendation

To apply for the scholarship, candidates must mail a completed application form, most recent sealed official transcript indicating area of study and grade point average, and two letters of recommendation from faculty members, employers, or other significant persons to the address below. Applications that are missing any of these items will not be considered. **All information should be postmarked by Friday, March 9, 2012:**

Stephanie Coad
Teng & Associates
205 N Michigan Ave
Suite 3600
Chicago, IL 60601

Any questions should be directed to Stephanie Coad at (312) 616-5068.



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I. Personal Information

Name _____
Last First Middle Initial

Address (School) _____
Number and Street City State Zip

(Home) _____
Number and Street City State Zip

Phone Number (Primary) _____ (Secondary) _____

Email Address _____

II. Education Background:

	Name	Dates Attended	Major	Month and Year of Graduation
High School	a. _____			
	b. _____			
College/University	a. _____			
	b. _____			

Current Academic Standing _____
(freshman, sophomore, junior, senior, graduate student yr.)

List any extracurricular activities in which you have participated. Indicate elected offices held and awards received (if any).

- a. Student Activities (Professional Societies, etc.) ASCE Membership No.
- _____
- _____
- b. Community Activities _____
- _____
- _____
- c. Other Non-Academic Activities _____
- _____
- _____
- d. Honors, Awards and Scholarships Received _____
- _____
- _____

III. Employment History:

List full-time employment, summer employment, or other part-time work below. Briefly explain duties and responsibilities. Begin with your most recent job. Attach additional sheets if necessary.

1. From _____ To _____
(Mo. /Yr.) (Mo. /Yr.)
- Business Name and Type of Business _____
- Address _____
- Primary Duties _____
- Hours per Week _____ Telephone Number _____
2. From _____ To _____
(Mo. /Yr.) (Mo. /Yr.)
- Business Name and Type of Business _____
- Address _____
- Primary Duties _____
- Hours per Week _____ Telephone Number _____

IV. List those persons who will be providing references. Please have letters of recommendation sent directly to Stephanie Coad, Teng & Associates, 205 N Michigan Ave, Suite 3600, Chicago, IL 60601

Name	Title	Email Address	Telephone Number
1. _____			
2. _____			

V. Attach a statement explaining why you are interested in pursuing a degree in the field of structural engineering, outlining your education and career objectives and goals. This statement should be no longer than 300 words.

VI. Attach a current sealed official transcript record of your coursework.

VII. I certify that the information provided on this application is true and correct and that this information may be used for the purpose of evaluation and selection of the Scholarship Award Recipient by the Scholarship Award Committee. I agree to provide proof of ASCE membership when requested by the selection committee. I understand that all information will be held confidential.

Signature _____ Date _____

NOTE: Please send completed application, statement and transcript to:

Stephanie Coad
Teng & Associates
205 N Michigan Ave
Suite 3600
Chicago, IL 60601